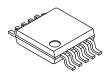
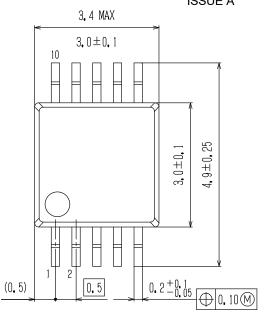
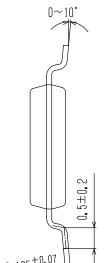
DATE 23 OCT 2013

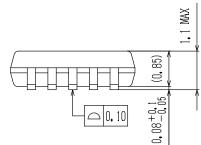


Micro10 / MSOP10 (150 mil) CASE 846AG **ISSUE A**

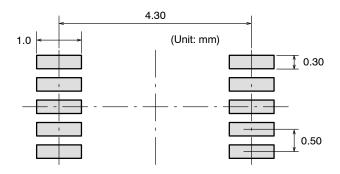




 $0.125^{+0.07}_{-0.02}$



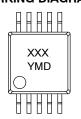
SOLDERING FOOTPRINT*



NOTE: The measurements are not to guarantee but for reference only.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

Y = Year

M = Month

D = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	MICRO10 / MSOP10 (150 MIL)		PAGE 1 OF 1

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